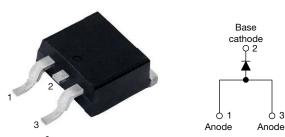


Vishay Semiconductors

# High Voltage Surface Mount Input Rectifier Diode, 20 A



| D2DAK | (TO-263AB)   |  |
|-------|--------------|--|
| D PAR | ( I U-203AD) |  |

| PRIMARY CHARACTERISTICS          |                               |  |  |  |  |
|----------------------------------|-------------------------------|--|--|--|--|
| I <sub>F(AV)</sub> 20 A          |                               |  |  |  |  |
| $V_{R}$                          | 800 V, 1200 V                 |  |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> | 1.1 V                         |  |  |  |  |
| I <sub>FSM</sub>                 | 300 A                         |  |  |  |  |
| T <sub>J</sub> max.              | 150 °C                        |  |  |  |  |
| Package                          | D <sup>2</sup> PAK (TO-263AB) |  |  |  |  |
| Circuit configuration            | Single                        |  |  |  |  |

#### **FEATURES**

- Glass passivated pellet chip junction
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C



- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- Input rectification
- Vishay Semiconductors switches and output rectifiers which are available in identical package outlines

#### **DESCRIPTION**

The VS-20ETS...S-M3 rectifier High Voltage Series has been optimized for very low forward voltage drop, with moderate leakage. The glass passivation technology used has reliable operation up to 150 °C junction temperature.

| OUTPUT CURRENT IN TYPICAL APPLICATIONS  |                     |                    |       |  |  |  |
|---|---------------------|--------------------|-------|--|--|--|
| APPLICATIONS  | SINGLE-PHASE BRIDGE | THREE-PHASE BRIDGE | UNITS |  |  |  |
| Capacitive input filter T <sub>A</sub> = 55 °C, T <sub>J</sub> = 125 °C common heatsink of 1 °C/W | 16.3                | 21                 | А     |  |  |  |

| MAJOR RATINGS AND CHARACTERISTICS   |                              |             |    |  |  |  |  |  |
|-------------------------------------|------------------------------|-------------|----|--|--|--|--|--|
| SYMBOL CHARACTERISTICS VALUES UNITS |                              |             |    |  |  |  |  |  |
| I <sub>F(AV)</sub>                  | Sinusoidal waveform          | 20          | A  |  |  |  |  |  |
| V <sub>RRM</sub>                    |                              | 800/1200    | V  |  |  |  |  |  |
| I <sub>FSM</sub>                    |                              | 300         | A  |  |  |  |  |  |
| V <sub>F</sub>                      | 20 A, T <sub>J</sub> = 25 °C | 1.1         | V  |  |  |  |  |  |
| TJ                                  |                              | -40 to +150 | °C |  |  |  |  |  |

| VOLTAGE RATINGS |   |   |                                  |
|-----------------|---|---|----------------------------------|
| PART NUMBER     | V <sub>RRM</sub> , MAXIMUM PEAK<br>REVERSE VOLTAGE<br>V | V <sub>RSM</sub> , MAXIMUM<br>NON-REPETITIVE PEAK REVERSE<br>VOLTAGE<br>V | I <sub>RRM</sub> AT 150 °C<br>mA |
| VS-20ETS08S-M3  | 800   | 900   | 1                                |
| VS-20ETS12S-M3  | 1200  | 1300  | 1                                |

| ABSOLUTE MAXIMUM RATINGS             |                    |   |        |                  |  |  |  |
|--------------------------------------|--------------------|---|--------|------------------|--|--|--|
| PARAMETER                            | SYMBOL             | TEST CONDITIONS   | VALUES | UNITS            |  |  |  |
| Maximum average forward current      | I <sub>F(AV)</sub> | T <sub>C</sub> = 105 °C, 180° conduction half sine wave | 20     |                  |  |  |  |
| Maximum peak one cycle               |                    | 10 ms sine pulse, rated V <sub>RRM</sub> applied        | 250    | Α                |  |  |  |
| non-repetitive surge current         | I <sub>FSM</sub>   | 10 ms sine pulse, no voltage reapplied                  | 300    |                  |  |  |  |
| Maximum I <sup>2</sup> t for fusing  | I <sup>2</sup> t   | 10 ms sine pulse, rated V <sub>RRM</sub> applied        | 316    | A <sup>2</sup> s |  |  |  |
| Maximum I-t for fusing               | 1-1                | 10 ms sine pulse, no voltage reapplied                  | 442    | A-5              |  |  |  |
| Maximum I <sup>2</sup> √t for fusing | I <sup>2</sup> √t  | t = 0.1 ms to 10 ms, no voltage reapplied               | 4420   | A²√s             |  |  |  |

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| •                         |        |                 |        |        |   |
|---------------------------|--------|-----------------|--------|--------|---|
| ELECTRICAL SPECIFICATIONS |        |                 |        |        |   |
| PARAMETER                 | SYMBOL | TEST CONDITIONS | VALUES | LINITS | İ |

| PARAMETER                             | SYMBOL             | TEST CONDITIONS              |   | VALUES | UNITS |
|---------------------------------------|--------------------|------------------------------|---|--------|-------|
| Maximum forward voltage drop          | $V_{FM}$           | 20 A, T <sub>J</sub> = 25 °C |   | 1.1    | V     |
| Forward slope resistance              | r <sub>t</sub>     | T <sub>J</sub> = 150 °C      |   | 10.4   | m $Ω$ |
| Threshold voltage                     | V <sub>F(TO)</sub> |                              |   | 0.85   | V     |
| Maximum reverse leakage current       | _                  | T <sub>J</sub> = 25 °C       | V <sub>R</sub> = Rated V <sub>RRM</sub> | 0.1    | mA    |
| iviaxiiiluiii reverse leakage current | IRM                | T <sub>J</sub> = 150 °C      | VR = nateu VRRM                         | 1.0    | IIIA  |

| THERMAL - MECHANICAL SPECIFICATIONS             |              |                                   |  |             |                  |  |
|---|--------------|-----------------------------------|--|-------------|------------------|--|
| PARAMETER                                       |              | SYMBOL                            | TEST CONDITIONS                          | VALUES      | UNITS            |  |
| Maximum junction and storage temper             | rature range | T <sub>J</sub> , T <sub>Stg</sub> |  | -40 to +150 | °C               |  |
| Maximum thermal resistance, junction to case    |              | R <sub>thJC</sub>                 | DC operation                             | 1.3         |                  |  |
| Maximum thermal resistance, junction to ambient |              | R <sub>thJA</sub> (1)             | For D <sup>2</sup> PAK version           | 62          | °C/W             |  |
| Typical thermal resistance, case to heatsink    |              | R <sub>thCS</sub>                 | Mounting surface, smooth, and greased    | 0.5         |                  |  |
| Approximate weight                              |              |                                   |  | 2           | g                |  |
| Approximate weight                              |              |                                   |  | 0.07        | OZ.              |  |
| Mounting torque -                               | minimum      |                                   |  | 6.0 (5.0)   | kgf · cm         |  |
| maxi  |              |                                   |  | 12 (10)     | (lbf $\cdot$ in) |  |
| Marking device                                  |              |                                   | Consideration D2DAY (TO 262AB)           | 20ETS08S    |                  |  |
|   |              |                                   | Case style D <sup>2</sup> PAK (TO-263AB) |             | 20ETS12S         |  |

#### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

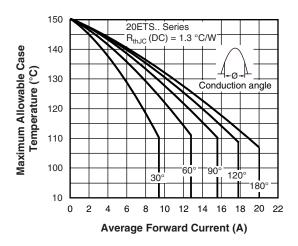


Fig. 1 - Current Rating Characteristics

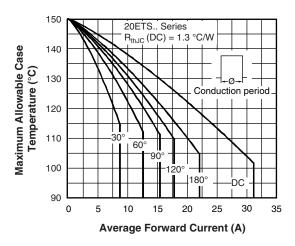


Fig. 2 - Current Rating Characteristics





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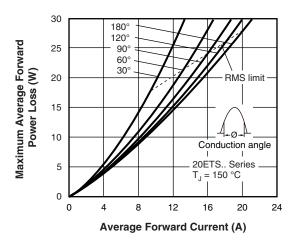


Fig. 3 - Forward Power Loss Characteristics

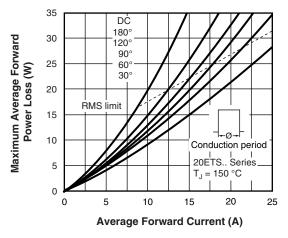


Fig. 4 - Forward Power Loss Characteristics

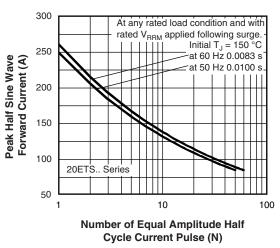


Fig. 5 - Maximum Non-Repetitive Surge Current

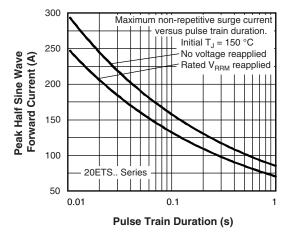


Fig. 6 - Maximum Non-Repetitive Surge Current

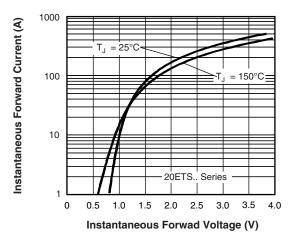


Fig. 7 - Forward Voltage Drop Characteristics

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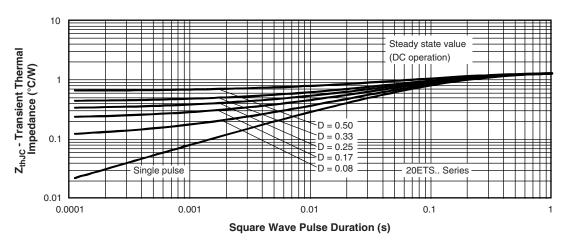
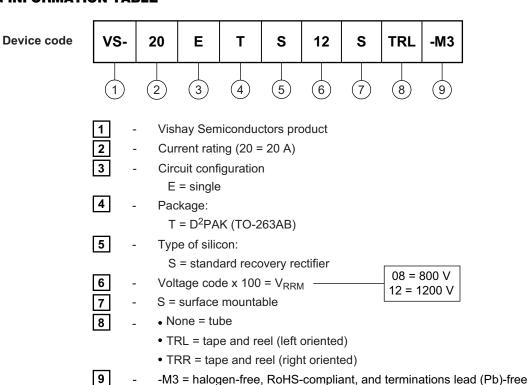


Fig. 8 - Thermal Impedance Z<sub>thJC</sub> Characteristics

#### **ORDERING INFORMATION TABLE**



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| ORDERING INFORMATION (Example)                    |     |                         |  |  |  |  |  |
|---|-----|-------------------------|--|--|--|--|--|
| PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION |     |                         |  |  |  |  |  |
| VS-20ETS08S-M3                                    | 50  | Antistatic plastic tube |  |  |  |  |  |
| VS-20ETS08STRR-M3                                 | 800 | 13" diameter reel       |  |  |  |  |  |
| VS-20ETS08STRL-M3                                 | 800 | 13" diameter reel       |  |  |  |  |  |
| VS-20ETS12S-M3                                    | 50  | Antistatic plastic tube |  |  |  |  |  |
| VS-20ETS12STRR-M3                                 | 800 | 13" diameter reel       |  |  |  |  |  |
| VS-20ETS12STRL-M3                                 | 800 | 13" diameter reel       |  |  |  |  |  |

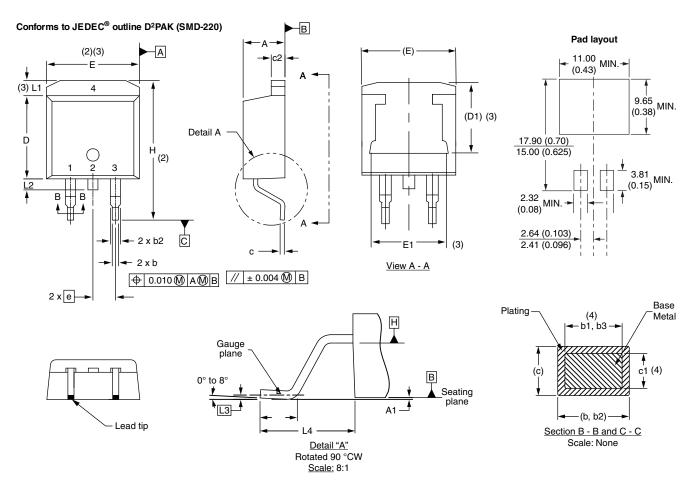
| LINKS TO RELATED DOCUMENTS |                          |  |  |  |
|----------------------------|--------------------------|--|--|--|
| Dimensions                 | www.vishay.com/doc?96164 |  |  |  |
| Part marking information   | www.vishay.com/doc?95444 |  |  |  |
| Packaging information      | www.vishay.com/doc?96424 |  |  |  |
| SPICE model                | www.vishay.com/doc?95409 |  |  |  |



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## D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



| SYMBOL   | MILLIM | MILLIMETERS |       | INCHES |       |
|----------|--------|-------------|-------|--------|-------|
| STIVIBUL | MIN.   | MAX.        | MIN.  | MAX.   | NOTES |
| Α        | 4.06   | 4.83        | 0.160 | 0.190  |       |
| A1       | 0.00   | 0.254       | 0.000 | 0.010  |       |
| b        | 0.51   | 0.99        | 0.020 | 0.039  |       |
| b1       | 0.51   | 0.89        | 0.020 | 0.035  | 4     |
| b2       | 1.14   | 1.78        | 0.045 | 0.070  |       |
| b3       | 1.14   | 1.73        | 0.045 | 0.068  | 4     |
| С        | 0.38   | 0.74        | 0.015 | 0.029  |       |
| c1       | 0.38   | 0.58        | 0.015 | 0.023  | 4     |
| c2       | 1.14   | 1.65        | 0.045 | 0.065  |       |
| D        | 8.51   | 9.65        | 0.335 | 0.380  | 2     |

| SYMBOL | MILLIMETERS |       | INCHES    |       | NOTES |
|--------|-------------|-------|-----------|-------|-------|
|        | MIN.        | MAX.  | MIN.      | MAX.  | NOTES |
| D1     | 6.86        | 8.00  | 0.270     | 0.315 | 3     |
| E      | 9.65        | 10.67 | 0.380     | 0.420 | 2, 3  |
| E1     | 7.90        | 8.80  | 0.311     | 0.346 | 3     |
| е      | 2.54 BSC    |       | 0.100 BSC |       |       |
| Н      | 14.61       | 15.88 | 0.575     | 0.625 |       |
| L      | 1.78        | 2.79  | 0.070     | 0.110 |       |
| L1     | -           | 1.65  | -         | 0.066 | 3     |
| L2     | 1.27        | 1.78  | 0.050     | 0.070 |       |
| L3     | 0.25 BSC    |       | 0.010 BSC |       |       |
| L4     | 4.78        | 5.28  | 0.188     | 0.208 |       |

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

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